# FMH40N60S1FD

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**FUJI POWER MOSFET** 

# **Super J-MOS series**

### N-Channel enhancement mode power MOSFET

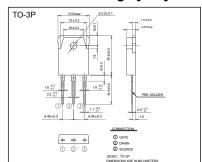
#### Features

Pb-free lead terminal RoHS compliant

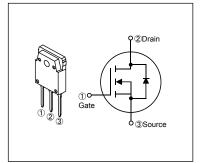
#### Applications

For switching

#### Outline Drawings [mm]



## Equivalent circuit schematic



#### ■ Absolute Maximum Ratings at T<sub>c</sub>=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Duain Sauras Valtaga	V <sub>DS</sub>	600	V	
Drain-Source Voltage	V <sub>DSX</sub>	600	V	V <sub>GS</sub> =-30V
Continuous Drain Current		±40	Α	Tc=25°C Note*1
Continuous Drain Current	l <sub>D</sub>	±25	Α	Tc=100°C Note*1
Pulsed Drain Current	I <sub>DP</sub>	±120	Α	Note*1
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	7.6	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	1390	mJ	Note *3
Maximum Drain-Source dV/dt	dV <sub>DS</sub> /dt	50	kV/μs	V <sub>DS</sub> ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	30	kV/μs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
	Pn	2.5	W	T <sub>a</sub> =25°C
Maximum Power Dissipation	P <sub>D</sub>	315	VV	Tc=25°C
On another and Otamana Tamananatura and a	Tch	150	°C	
Operating and Storage Temperature range	T <sub>stg</sub>	-55 to +150	°C	

Eas limited by maximum channel temperature and avalanche current. Note \*4 : IF  $\le$  -ID, -di/dt=100A/ $\mu$ s, VDs peak  $\le$  600V, Tch  $\le$  150°C.

Note \*5 : IF  $\leq$  -ID, dV/dt=30kV/ $\mu$ s, VDs peak  $\leq$  600V, Tch  $\leq$  150°C.

#### ■ Electrical Characteristics at T<sub>c</sub>=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA V <sub>GS</sub> =0V		600	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =1.5mA V <sub>DS</sub> =V <sub>GS</sub>		3	4	5	V
Zero Gate Voltage Drain Current	Inss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	μА
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	T <sub>ch</sub> =125°C	-	300	-	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ± 30V V <sub>DS</sub> =0V		-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =20A V <sub>GS</sub> =10V		-	0.079	0.093	Ω
Gate resistance	R <sub>G</sub>	f=1MHz, open drain		-	1.1	-	Ω

Note \*1 : Limited by maximum channel temperature. Note \*2 :  $T_{ch} \le 150^{\circ}C$ , See Fig.1 and Fig.2 Note \*3 : Starting  $T_{ch} = 25^{\circ}C$ ,  $I_{AS} = 4.6A$ , L = 120 mH,  $V_{DD} = 60$ V,  $R_{G} = 50\Omega$ , See Fig.1 and Fig.2

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### • Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g <sub>fs</sub>	I <sub>D</sub> =20A V <sub>DS</sub> =25V	14.5	29	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =400V	-	2865	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	83	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	6.5	-	
Effective output capacitance, energy related (Note *6)	C <sub>o(er)</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =0400V	-	216	-	pF
Effective output capacitance, time related (Note *7)	C <sub>o(tr)</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =0400V ID=constant	-	758	-	
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V I <sub>D</sub> =20A, R <sub>G</sub> =13Ω See Fig.3 and Fig.4	-	124	-	
Turn-On Time	<b>t</b> r		-	29	-	ns
Turn-Off Time	t <sub>d(off)</sub>		-	139	-	
Turn-On Time	<b>t</b> f		-	19	-	
Total Gate Charge	Q <sub>G</sub>		-	104	-	
Gate-Source Charge	Q <sub>GS</sub>	V <sub>DD</sub> =400V, I <sub>D</sub> =40A V <sub>GS</sub> =10V See Fig.5	-	27	-	nC
Gate-Drain Charge	Q <sub>GD</sub>		-	46	-	IIC
Drain-Source crossover Charge	Qsw		-	14	-	

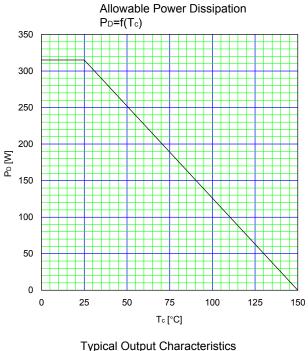
Note \*6 :  $C_{\text{o(er)}}$  is a fixed capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 400V. Note \*7 :  $C_{\text{o(er)}}$  is a fixed capacitance that gives the same charging times as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 400V.

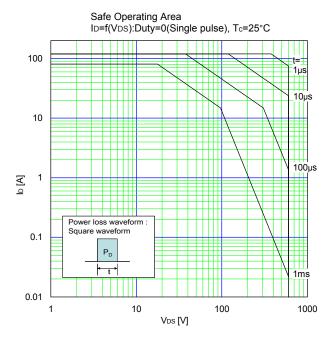
#### • Reverse Diode

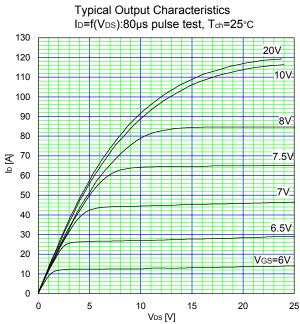
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=26.7mH,T <sub>ch</sub> =25°C See Fig.1 and Fig.2	7.6	-	-	Α
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =40A,V <sub>GS</sub> =0V T <sub>ch</sub> =25°C	-	1.1	1.35	V
Reverse Recovery Time	trr	I <sub>F</sub> =40A, V <sub>DD</sub> =400V -di/dt=100A/μs T <sub>ch</sub> =25°C See Fig.6 and Fig.7	-	200	-	ns
Reverse Recovery Charge	Qrr		-	1.35	-	μC
Peak Reverse Recovery Current	Irp		-	13.5	-	А

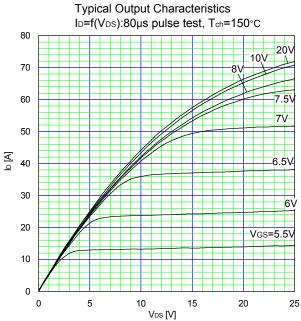
#### ■ Thermal Resistance

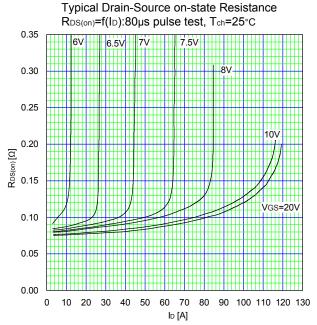
Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R <sub>th(ch-c)</sub>	-	-	0.40	°C/W
Channel to Ambient	R <sub>th(ch-a)</sub>	-	-	50	°C/W

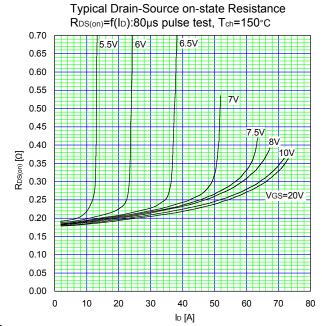


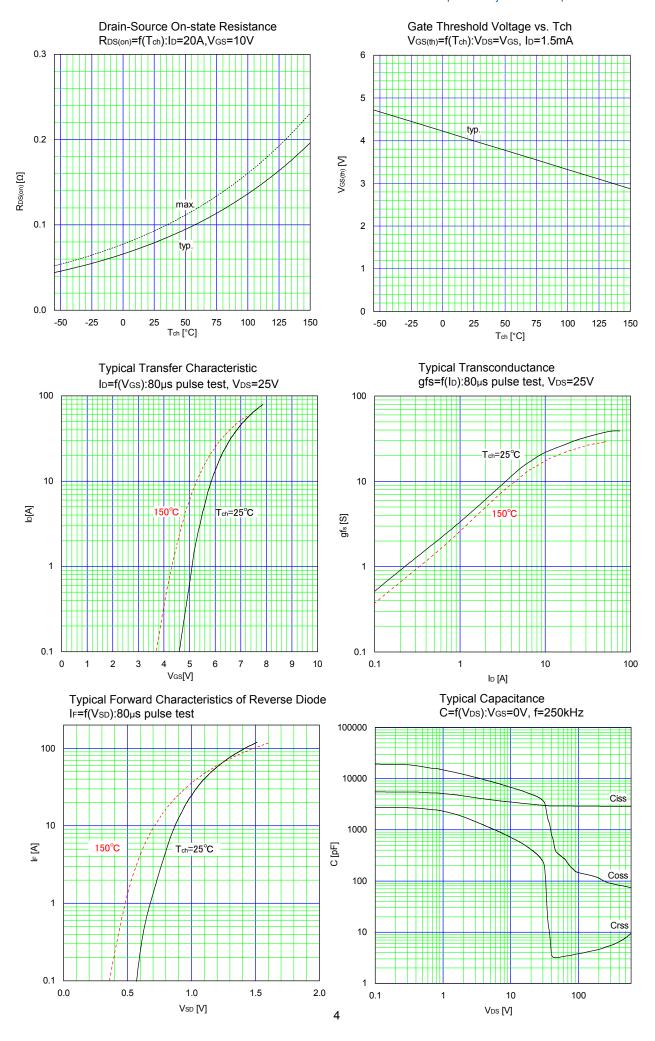


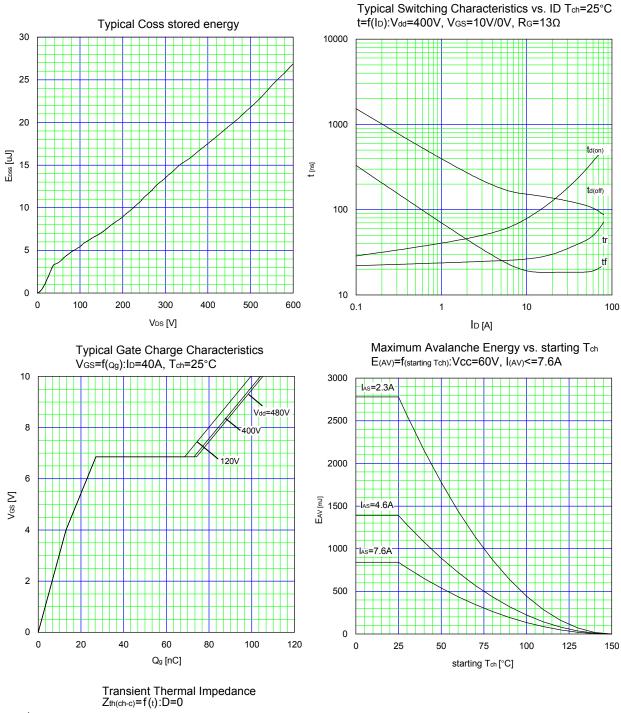












Transient I hermal Impedance  $Z_{th(ch-c)}=f(t):D=0$ 10<sup>1</sup>
10<sup>2</sup>
10<sup>3</sup>
10<sup>6</sup>
10<sup>5</sup>
10<sup>4</sup>
10<sup>3</sup>
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10<sup>1</sup>
10<sup>2</sup>

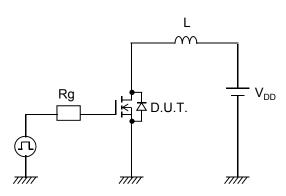


Fig.1 Avalanche Test circuit

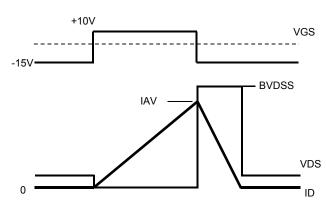


Fig.2 Operating waveforms of Avalanche Test

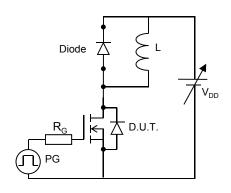


Fig.3 Switching Test circuit

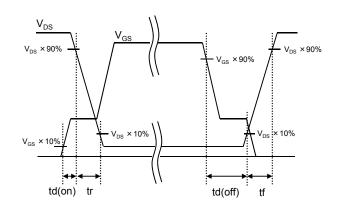


Fig.4 Operating waveform of Switching Test

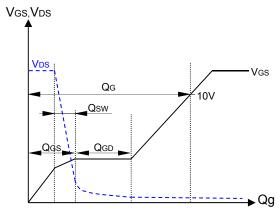


Fig.5 Operating waveform of Gate charge Test

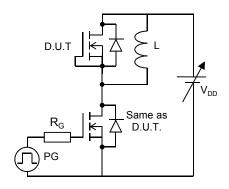


Fig.6 Reverse recovery Test circuit

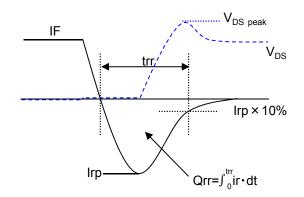
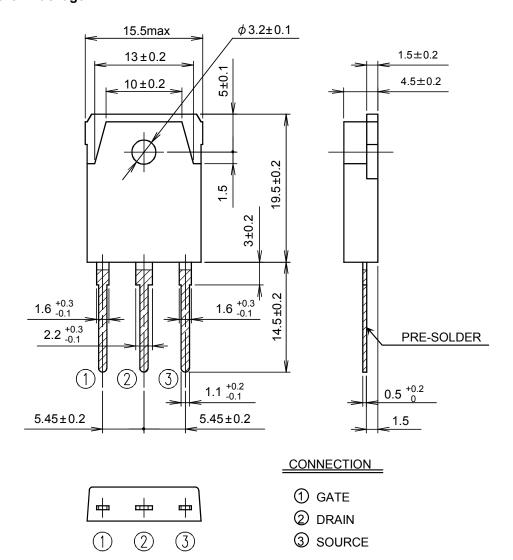
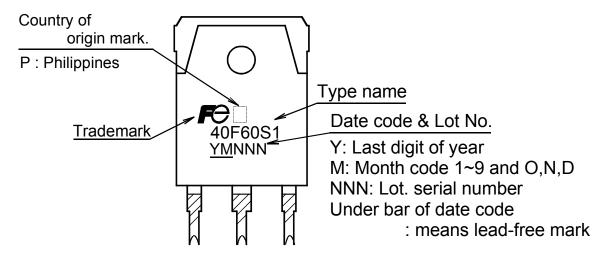


Fig.7 Operating waveform of Reverse recovery Test

#### Outview: TO-3P Package



# Marking



JEDEC: TO-3P

DIMENSIONS ARE IN MILLIMETERS.

<sup>\*</sup> The font (font type,size) and the trademark-size might be actually different.

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